imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

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NPN Low Saturation Transistor

These devices are designed for high current gain and low saturation voltage with collector currents up to 3.0 Å continuous. Sourced from Process NA.

Absolute Maximum Ratings* TA = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{CEO}	Collector-Emitter Voltage	60	V
V _{CBO}	Collector-Base Voltage	80	V
V _{EBO}	Emitter-Base Voltage	5.0	V
Ic	Collector Current - Continuous	3.0	А
T _J , T _{stg}	Operating and Storage Junction Temperature Range	-55 to +150	°C

*These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES: 1) These ratings are based on a maximum junction temperature of 150 degrees C. 2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Thermal Characteristics TA = 25°C unless otherwise noted

Symbol	Characteristic	Max	Units
		FPN560 / FPN560A	
PD	Total Device Dissipation	1.0	W
R _{0JC}	Thermal Resistance, Junction to Case	50	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	125	°C/W

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	NPN Low Saturation Transis (conti				nsistor
Electri	ical Characteristics TA=25	°C unless otherwise noted			
Symbol	Parameter	Test Conditions	Min	Max	Units
OFF CHAI	RACTERISTICS				
BV _{CEO}	Collector-Emitter Breakdown Voltage	$I_{C} = 10 \text{ mA}, I_{B} = 0$	60		V
BV _{CBO}	Collector-Base Breakdown Voltage	$I_{\rm C} = 100 \ \mu {\rm A}, \ I_{\rm E} = 0$			V
BV _{EBO}	Emitter-Base Breakdown Voltage	$I_E = 100 \ \mu A, I_C = 0$	5.0		V
I _{СВО}	Collector Cutoff Current			100 10	nA μA
I _{EBO}	Emitter Cutoff Current	$V_{EB} = 4.0 \text{ V}, I_{C} = 0$		100	nA
ON CHAR	ACTERISTICS*	Ic = 100 mA. VcF = 2.0 V	70	1	
11FE		$\begin{array}{c} I_{C} = 100 \text{ mA}, \text{ V}_{CE} = 2.0 \text{ V} \\ I_{C} = 500 \text{ mA}, \text{ V}_{CE} = 2.0 \text{ V} \\ I_{C} = 1.0 \text{ A}, \text{ V}_{CE} = 2.0 \text{ V} \\ I_{C} = 2.0 \text{ A}, \text{ V}_{CE} = 2.0 \text{ V} \end{array}$	100	300 550	
V _{CE(sat)}	Collector-Emitter Saturation Voltage	$ \begin{array}{c} l_{\rm C} = 1.0 \ \text{A}, \ l_{\rm B} = 100 \ \text{mA} \\ l_{\rm C} = 2.0 \ \text{A}, \ l_{\rm B} = 200 \ \text{mA} \\ \end{array} $		300 350 300	mV mV mV
V _{BE(sat)}	Base-Emitter Saturation Voltage	I _C = 1.0 A, I _B = 100 mA		1.25	V

SMALL SIGNAL CHARACTERISTICS

Base-Emitter Saturation Voltage

 $V_{\text{BE}(\text{on})}$

Cobo	Output Capacitance	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1.0 \text{ MHz}$		30	pF
FT	Transition Frequency	$I_{C} = 100 \text{ mA}, V_{CE} = 5.0 \text{ V},$ f = 100 MHz	75		MHz

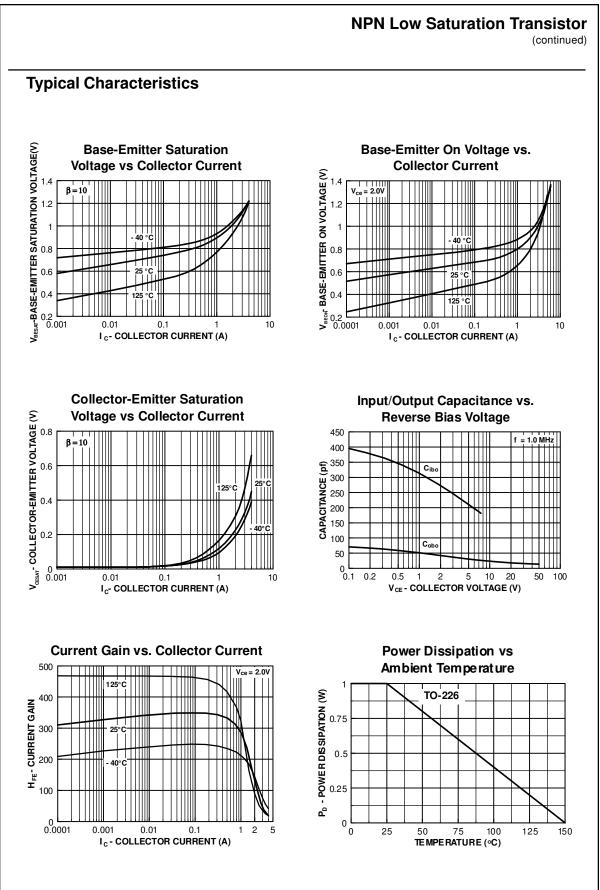
 $I_C = 1.0 \text{ A}, V_{CE} = 2.0 \text{ V}$

*Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%

FPN560 / FPN560A

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FPN560 / FPN560A

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Datasheet Identification	Product Status	Definition
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